

**WEST****Searches for User *jhollington* (Count = 8740)****Queries 8691 through 8740.**[Next](#)[Oldest](#)[Edit](#)[Help](#)[Return](#)[Main Menu](#)[Logout](#)

S #	Updt	Database	Query	Time	Comment
<u>S8740</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and blow\$ air	2002-12-06 14:07:58	
<u>S8739</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and blowing air	2002-12-06 14:07:36	
<u>S8738</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and air blower	2002-12-06 14:07:11	
<u>S8737</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and air blow	2002-12-06 14:06:58	
<u>S8736</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and air	2002-12-06 13:29:21	
<u>S8735</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	((burn-in (device or apparatus) )and wafer ) and air hole	2002-12-06 13:29:08	
<u>S8734</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(burn-in (device or apparatus) ) and electrode	2002-12-06 12:25:57	
<u>S8733</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(burn-in (device or apparatus) ) and wafer	2002-12-06 12:24:58	
<u>S8732</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	burn-in (device or apparatus)	2002-12-06 12:23:50	
<u>S8731</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	burn-in and heated air	2002-12-06 11:13:28	
<u>S8730</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD	burn-in and air	2002-12-06	

		blower	10:42:14
<u>S8729</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (((wafer and vacuum )and ((324/\$)!.CCLS.) )and burn-in )and hole ) and electrode	2002-12-06 10:15:57
<u>S8728</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (((wafer and vacuum )and ((324/\$)!.CCLS.) )and burn-in ) and hole	2002-12-06 10:15:25
<u>S8727</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD ((wafer and vacuum )and ((324/\$)!.CCLS.) ) and burn-in	2002-12-06 10:15:06
<u>S8726</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (wafer and vacuum ) and ((324/\$)!.CCLS.)	2002-12-06 10:14:49
<u>S8725</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD wafer and vacuum	2002-12-06 10:14:34
<u>S8724</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD ((wafer and holding plate )and through hole ) and ((324/\$)!.CCLS.)	2002-12-06 10:06:52
<u>S8723</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (wafer and holding plate ) and through hole	2002-12-06 10:06:33
<u>S8722</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD wafer and holding plate	2002-12-06 10:06:16
<u>S8721</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD wafer and holding plat	2002-12-06 10:06:05
<u>S8720</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (((program\$ logic device or PLD )and memory cell )and interconnect ) and heat\$3	2002-12-05 12:58:18
<u>S8719</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (((program\$ logic device or PLD )and memory cell )and interconnect ) and heat\$	2002-12-05 12:55:12
<u>S8718</u>	<u>U</u>	USPT,PGPB,JPAB,EPAB,DWPI,TDBD (((program\$ logic device or PLD )and memory cell )and interconnect )and test signal ) and burn-in	2002-12-05 12:24:10

For 09/904663